

PARTEC 2019

International Congress on Particle Technology

April 9–11, 2019, Nürnberg, Germany



www.partec.info

Submission Deadline

Submission Deadline April 30, 2018

together with:



Honorary Sponsor:





Purpose

Modern production processes in chemical, pharmaceutical and biological industries are characterized by solids processes with complex process structures.

Grand challenges has been achieved to better understand and to adjust processes for particle product design and the corresponding and required product properties, which are of multiscale nature.

Besides this classical fields the PARTEC, as one of the largest international particle and powder technology conferences, wants to adress also emerging fields of applications of particle technology in life sciences and medicine, environmental and energy technology, synthesis reactions, materials science, electronics, photonics and additive manufacturing, which influence our daily life.

For this reasons the major topic of the next PARTEC in 2019 is "Particles for a better life".

PARTEC attracts a very wide mix of attendees, from both academia and industry, all meeting together in the same place and surrounded by POWTECH, the world's leading exhibition for the processing, analysis and handling of powder and bulk solids.

I would therefore like to invite the academic world and the representatives from the industry to take part in this important event. I look forward to meeting you at PARTEC 2019.

Prof. Dr.-Ing. Stefan Heinrich

Head of the Institute of Solids Process Engineering and Particle Technology of the Hamburg University of Technology (TUHH) Chairman of PARTEC 2019

Scientific Committee

Luding, S. - UT, Netherlands

Matsusaka, S. – U. Kyoto, Japan

Antonyuk, S. - TU Kaiserslautern, Germany Arastoopour, H. - IIT, USA Bowen, P. - EPFL Switzerland Braun, M. - Ansys Germany GmbH, Germany Butt, H.-J. - MPIP, Germany Chaouki, J. - EPM, Canada Cocco. R. – PSRI. USA Cölfen, H. - U. Konstanz, Germany Coppens, M.-O. - UCL - Engineering, UK Dave, R.-N. - NJIT, USA Fan. L.-S. - U. Ohio State. USA Fritsching, U. - U. Bremen, Germany Frye, L. - Bayer AG, Germany Fuji, M. - NITech, Japan Ghadiri, M. - U. Leeds, UK Herrmann, H. J. – ETH Zürich, Switzerland Jacob, M. - Glatt Ingenieurtechnik GmbH, Germany Jacob, K. - Dow Chemical Company, USA John, E. - Novartis Pharma AG, Switzerland Kalman, H. – BGU Negev, Israel Khinast, J. - TU Graz, Austria Kind, M. - KIT, Germany Kleinebudde, P. - HHU Düsseldorf, Germany Klupp-Taylor, R. - FAU Erlangen, Germany Kraus, T. - INM - Leibniz, Germany Kuipers, J.A.M. - U. Eindhoven, Netherlands Lettieri, P. - UCL, UK Li. J. - CAS. China Litster, J. - U. Sheffield, UK

Meesters, G.M.H. - TU Delft, Netherlands Miller, R. - MPI of collids and Interfaces, Germany Mühlenweg, H. – Evonik, Germany Muzzio, F. J. - SoE Rutgers, USA Naito, M. – U. Osaka, Japan Ooi, J. - U. Edinbugh, UK Palzer, S. - Nestlé Research Center, Switzerland Peglow, M. - IPT-Pergande GmbH, Germany Pirker, S. – JKU Linz, Austria Prastinis, S. - ETH Zurich, Switzerland Pui, D.Y.H. - U. Minnesota, USA Riebel, U. - BTU Cottbus, Germany Röthele, S. - Sympatec GmbH, Germany Salman, A.D. - U. Sheffield, UK Satoru, W. – OPU, Japan Schmidt, E. – BUW, Germany Schneider, H. - Zeppelin Systems GmbH, Germany Schneider, G. - TU Hamburg, Germany Seville, J.P.K. - U. Birmingham, UK Sundaresan, S. - U. Princeton, USA Teipel, U. - TH Nürnberg, Germany Tsotsas, E. – OvGU Magdeburg, Germany van Ommen, R. - TU Delft, Netherlands Walker, G. - U. Limerick, Ireland Weber, A.D. - TU Clausthal, Germany Weimer, A.W. - U. Colorado, USA Weinekötter, R. - Gericke AG, Switzerland Witt, W. - Sympatec GmbH, Germany Wollny, M. - Merck KGaA, Germany

Yu, A. - Monash University, Australia

Executive Committee

Heinrich, S. - Hamburg University of Technology, Germany

Kleine Jäger, F. - BASF SE, Germany

Kwade, A. - TU Braunchweig, Germany

Mädler, L. - Stiftung Institut für Werkstofftechnik Bremen, Germany

Nirschl, H. - Karlsruhe Institute of Technology, Germany

Peuker, U. - TU Bergakademie Freiberg, Germany

Peukert - W. Erlangen University, Germany

Topics and Subjects

PARTEC welcomes contributions from researchers in universities, industrial companies and other research organizations. Industry specific and also joined research proposals between industry and research organizations are appreciated. Contributions covering all aspects of particle science and applications are welcome.

Subjects of interest can include:

(Nano)-Structured Materials

- Formation and synthesis of particles in gas and liquid phases
- Structuring of aggregates, granules, crystals, precipitates, aerosols
- Characterization of particles (shape, size, pores, strength, rheology...)

Interface Controlled Processes

Control of agglomeration, granulation, comminution...

- Modification/structuring/coating of surfaces
- Characterization of surface modifications

Applications of Particle Technology

- Manufacturing of particles for chemicals, electronics, pigments ...
- Economics of product development

Particles and Energy

- Particles for batteries, biorefineries
- Formation of particulate materials for energy processes
- Structure and performance

Modelling and Simulation

- CFD, DEM, population dynamics, Lattice-Boltzmann etc. methods for particulate processes
- Process evaluation with simulation
- Simulation of multiphase flows, surface properties, interaction behavior etc.

Life & Food Science

- Particles in food and biological processes (particulate food ingredients, algae...)
- Biological behavior and structural properties

Particles in Contact and Processing

- Contact mechanics of particle interaction (adhesion, cohesion)
- Processing and modification of particles
- Characterization of contact properties

Particles from Renewable Materials

- Recycling of particulate products
- Methods for particle recovering (attrition, classification...)

Pharmaceutical Particles

- Particle structure and pharmaceutical functionality
- Effects on health, environment...

Call for Submission of Contributions

Are you an expert on one of the areas of our topics? Then we call on you to make an active contribution to the success of the congress with a presentation.

Please submit a brief abstract of max. one A4 page by April 30, 2018, summarizing your presentation. You can submit your paper at **www.partec.info**

TYPES OF CONTRIBUTION

Your contribution can take the form of:

- 1. a full presentation:
 - If your paper is accepted you will be allowed to speak 15 minutes, with additional 5 minutes for discussion
- a poster presentation:
 The posters will be presented in a relaxed atmosphere on April 9, 2019.

SUBMISSION OF ABSTRACTS

If you want to present a contribution your submission must include:

- Title of the paper and/or poster
- An abstract summarizing your paper
- Information about the lecturer and coauthors: name, title(s), company address, department, affiliation, e-mail, telephone and fax number

- In which topic area(s) your presentation should be listed
- How you would like to present your paper upon acceptance (full or poster presentation)
 All abstracts will be reviewed. Please note that abstracts and final papers will be only accepted if they are uploaded to the conference's website:

www.partec.info

All submissions must be either Microsoft WORD (DOC or DOCX) or Portable Document Format (PDF) files. Your abstract must be received by April 30, 2018. Based on the abstract, the programme committee will decide on the acceptance and order of presentation in the conference programme. Please note that the number of co-authors named in the printed programme is limited up to two.

SUBMISSION OF THE FINAL MANUSCRIPT

If your paper is accepted you will be invited to submit the final manuscript which must be received by January 11, 2019 the latest. If you receive notification of acceptance, you will also receive instructions concerning manuscripts and a question form to be returned to the VDI Wissensforum. The accepted papers (full papers and posters) will be published in the conference proceeding USB-Stick provided to the conference participants.

Schedule

- Deadline for submission of abstracts April 30, 2018
- Notification of acceptance September 2018
- Final programme available in October 2018
- Deadline for submission of manuscripts January 11, 2019

General Information

The conference will last three days, comprising keynote addresses and presentations in a series of plenary and parallel sessions. The official language of the conference will be English. No simultaneous translation will be provided. The conference programme will be available in October 2018.

Travel expenses will not be paid.

Sponsors





Supporting Organisations



International Association for Pharmaceutical Technology (APV), Germany



The Chinese Academy of Sciences (CAS), China



German Association of Biotechnology Industries (DIB), Germany



Deutsche Keramische Gesellschaft (DKG), Germany



Deutscher Schüttgut-Industrie Verband (DSIV), Germany



The Chemical Industry and Engineering Society of China



IChemE PTSIG



The Research Association of the German Food Industry (FEI), Germany



Association for Aerosol Research (GAeF), Germany



VDI Society Chemical and Process Engineering (VDI-GVC), Germany



AIChE's Particle Technology Forum (AIChE's PTF), USA



Society of Powder Technology

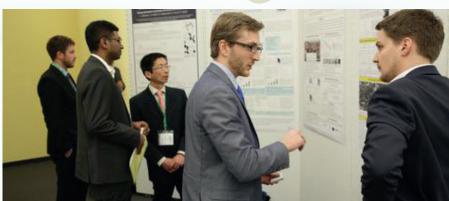


ProcessNet



Nano in Germany, Germany







Call for Papers PARTEC 2019

I shall be attending the International Congress on Particle Technology PARTEC 2019 on April 9-11, 2019 in Nürnberg, Germany (99TA001019)

3 Day Ticket*	Early booking (until January 11, 2019)	Regular Price	On Site Price
3-days regular price	EUR 778	EUR 934	EUR 1,074
3-days academics, speakers, poster presenters	EUR 583	EUR 699	EUR 805
3-days student (BSc, MSc, PhD students)	EUR 302	EUR 362	EUR 417
Day Ticket*			<u> </u>
l-day regular price	-	-	EUR 551
1-day academics, speakers, poster presenters	-	-	EUR 396
1-day student	-	-	EUR 204
Social Event*		·	
Exhibition Party on April 10, 2019 (19-24 h)		EUR 27	☐ EUR 27
Price per Person + VAT (The VAT directive of th	ne respective country applie	25)	,
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VDI Wissensforum GmbH P.O. Box 10 11 39 40002 Düsseldorf Phone: +49 211 6214-201

Fax: +49 211 6214-154 Email: wissensforum@vdi.de

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Registration: Registrations for conference attendance must be made in writing. Confirmation of your registration and the associated invoice will be mailed to you. Please do not pay your conference attendance fee until you have received our invoice and its invoice number to be stated for transfer.

Conference Venue:

Exhibition Centre Nuremberg, Messezentrum, 90471 Nürnberg, Germany

Cooperation Partner

Abstract + Registration Management:

VDI Wissensforum GmbH, VDI-Platz 1, 40468 Düsseldorf, Germany

Organizer:

NürnbergMesse GmbH, Messezentrum, 90471 Nürnberg, Germany

Hotel Reservation:

hotels@nuernbergmesse.de

For booking please visit www.partec.info/hotel

Nuremberg and the surrounding region offer you many possibilities for overnight accommodation. You can also contact us directly: PartnerHotels NürnbergMesse MesseService – Exhibition Services
Tel +49 911 8606-8415

Delegate benefits: The conference package includes the conference proceedings on USB-Stick, coffee-break beverages, lunch and the Get together on April 9, 2019.

Conference attendance conditions and terms: By way of your registration you accept the conference attendance conditions and terms of $\overline{\text{VDI Wissensforum GmbH}}$ as binding. Any cancellation of your registration must be made in writing. We will charge you only an administrative fee of € 50.00 plus German VAT if you cancel your registration earlier than 14 days ahead of the conference date. Any cancellation that reaches us after this deadline will entail the conference attendance fee as stated in our invoice to be charged in full. The date of the post office stamp of your written cancellation will be the decisive criterion. In that case, we will gladly mail you the conference documents on request. Subject to agreement, you may name a substitute participant. Individual parts and sections of conferences and seminars cannot be booked. You will be informed without delay if an event has to be cancelled for unforesee able reasons. In that instance, you will be entitled only to a refund of your conference attendance fee if already paid. We reserve the right to exchange speakers and/or change the program sequence in exceptional cases. In any case, the liability of VDI Wissensforum GmbH is restricted exclusively to the conference attendance fee

Consent of the use of data protection: By way of your registration you accept that VDI Wissensforum GmbH and the organizer NürnbergMesse GmbH captures and processes the address data of conference participants for their own corporate advertising purposes, enabling renowned companies and institutes to reach out to participants by way of information and offers within their own marketing activities. We have outsourced in part the technical implementation of data processing to external service providers. If you do not want to receive any information and offers in the future, you may contradict the use of your personal data by us or any third parties for advertising purposes. In that case, kindly notify us of your contradiction by using the e-mail address wissensforum@vdi.de or any other of the contact options.